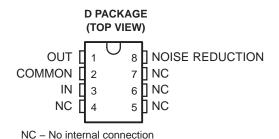
SGLS252A - AUGUST 2004 - REVISED JUNE 2008

- **Qualified for Automotive Applications**
- 1/2 V_I Virtual Ground for Analog Systems
- Micropower Operation . . . 170 μA Typ, $V_1 = 5 V$
- Wide VI Range . . . 4 V to 40 V
- **High Output-Current Capability**
 - Source . . . 20 mA Typ
 - Sink . . . 20 mA Typ
- **Excellent Output Regulation**
 - $-102 \,\mu\text{V}$ Typ at $I_{O} = 0$ to $-10 \,\text{mA}$
 - $+49 \mu V$ Typ at $I_0 = 0$ to +10 mA
- Low-Impedance Output . . . 0.0075 Ω Typ
- **Noise Reduction Pin**

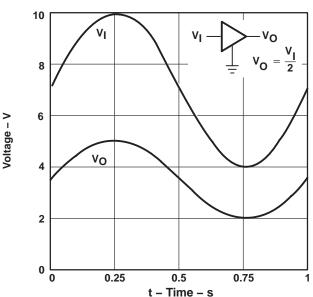
description

In signal-conditioning applications utilizing a single power source, a reference voltage equal to one-half the supply voltage is required for termination of all analog signal grounds. Texas Instruments presents a precision virtual ground whose output voltage is always equal to one-half the input voltage, the TLE2426 rail splitter.

The unique combination of a high-performance, micropower operational amplifier and a precisiontrimmed divider on a single silicon chip results in a precise V_O/V_I ratio of 0.5 while sinking and sourcing current. The TLE2426 provides a low-impedance output with 20 mA of sink and



INPUT/OUTPUT TRANSFER CHARACTERISTICS



source capability while drawing less than 280 µA of supply current over the full input range of 4 V to 40 V. A designer need not pay the price in terms of board space for a conventional signal ground consisting of resistors, capacitors, operational amplifiers, and voltage references. For increased performance, the 8-pin package provides a noise-reduction pin. With the addition of an external capacitor (CNR), peak-to-peak noise is reduced while line ripple rejection is improved.

Initial output tolerance for a single 5-V or 12-V system is better than 1% over the full 40-V input range. Ripple rejection exceeds 12 bits of accuracy. Whether the application is for a data acquisition front end, analog signal termination, or simply a precision voltage reference, the TLE2426 eliminates a major source of system error.

ORDERING INFORMATION[†]

TA	PACKA	PACKAGE [‡]		TOP-SIDE MARKING	
-40°C to 125°C	SOIC (D)	Tape and Reel	TLE2426QDRQ1	2426Q1	

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

[‡] Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



TLE2426-Q1 THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND

SGLS252A - AUGUST 2004 - REVISED JUNE 2008

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Continuous input voltage, V _I	
Continuous filter trap voltage	
Output current, IO	±80 mA
Duration of short-circuit current at (or below) 25°C (see Note 1)	unlimited
Continuous total power dissipation	. See Dissipation Rating Table
Operating free-air temperature range, T _A : Q suffix	–40°C to 125°C
Storage temperature range, T _{stq}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D package	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{\sc A}} \le 25^{\circ}\mbox{\sc C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	1102 mV	10.3 mW/°C	638.5 mW	484 mW	72.1 mW

recommended operating conditions

	MIN	MAX	UNIT
Input voltage, V _I	4	40	V
Operating free-air temperature, T _A	-40	125	°C



NOTE 1: The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

electrical characteristics at specified free-air temperature, $V_I = 5 V$, $I_O = 0$ (unless otherwise noted)

PARAMETER	TEST CONDITIO	TEST CONDITIONS		MIN	TYP	MAX	UNIT	
	V _I = 4 V	V _I = 4 V		1.98	2	2.02	V	
	V _I = 5 V	25°C	2.48	2.5	2.52			
Output voltage	V _I = 40 V		19.8	20	20.2			
	V _I = 5 V	Full range	2.465		2.535]		
Temperature coefficient of output voltage			Full range		25		ppm/°C	
0 1 .		V _I = 5 V	25°C		170	300	μА	
Supply current	No load	V _I = 4 to 40 V	Full range			400		
	1 01- 404		25°C		-0.102	±0.7		
Output voltage regulation sourcing current)‡	$I_{O} = 0 \text{ to } -10 \text{ mA}$		Full range			±10	mV	
(Sourcing current)+	$I_0 = 0 \text{ to } -20 \text{ mA}$		25°C	25°C				
Output voltage regulation (sinking current)‡	$I_O = 0$ to 10 mA	25°C		0.049	±0.5			
	$I_O = 0$ to 8 mA	Full range			±10	mV		
(Sinking current)	$I_O = 0$ to 20 mA	25°C		0.175	±1.4			
Output impedance‡			25°C		7.5	22.5	mΩ	
Noise-reduction impedance			25°C		110		kΩ	
Oh ant almost assument	Sinking current,	V _O = 5 V	0500		26			
Short-circuit current	Sourcing current,	VO = 0	Full range 25°C -0.12° 25°C 0.049 Full range 25°C 0.179 25°C 7.9 25°C 110 / 25°C -4 25°C -4 25°C 30 25°C 30	-47		mA		
Output a discoultant man	6 4011-1-40111-	$C_{NR} = 0$	0500	120		.,		
Output noise voltage, rms	f = 10 Hz to 10 kHz	C _{NR} = 1 μF	25°C	30			μν	
	V 12 0 400 1 140 mA	C _L = 0	0500		290			
	V_{O} to 0.1%, $I_{O} = \pm 10 \text{ mA}$	C _L = 100 pF	25°C	275]		
Output voltage current step response	V= to 0.040/	C _L = 0	0500		400) μ		
	V_{O} to 0.01%, $I_{O} = \pm 10 \text{ mA}$	C _L = 100 pF	25°C		390			
Ston response	$V_I = 0 \text{ to } 5 \text{ V}, V_O \text{ to } 0.1\%$	C _I = 100 pF	25°€		20			
Step response	$V_I = 0 \text{ to } 5 \text{ V}, V_O \text{ to } 0.01\%$		00 pF 25°C		120			

[†] Full range is –40°C to 125°C. ‡ The listed values are not production tested.

TLE2426-Q1 THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND SGLS252A – AUGUST 2004 – REVISED JUNE 2008

electrical characteristics at specified free-air temperature, V_{I} = 12 V, I_{O} = 0 (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T _A †	MIN	TYP	MAX	UNIT	
	V _I = 4 V		25°C	1.98	2	2.02	V	
Code double as	V _I = 12 V	5.95		6	6.05			
Output voltage	V _I = 40 V		19.8	20	20.2			
	V _I = 12 V		Full range	5.925		6.075		
Temperature coefficient of output voltage		Full range		35		ppm/°C		
Our mile account	Ma taad	V _I = 12 V	25°C		195	300		
Supply current	No load	V _I = 4 to 40 V	Full range			400	μΑ	
	La = 0 to 10 mA		25°C		-1.48	±10		
Output voltage regulation (sourcing current)‡	10 = 0.10 - 10 mA		Full range			±10	mV	
(Sourcing current)+	$I_0 = 0 \text{ to } -20 \text{ mA}$	25°C		-3.9	±10			
	I _O = 0 to 10 mA		25°C		2.27	±10		
Output voltage regulation	I _O = 0 to 8 mA	Full range			±10	mV		
(sinking current)‡	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		4.3	±10				
Output impedance [‡]			25°C		7.5	22.5	mΩ	
Noise-reduction impedance			25°C		110		kΩ	
	Sinking current, $V_O = 12 \text{ V}$		0500		31		mA	
Short-circuit current	Sourcing current,	V _O = 0	25°C	-70				
		$C_{NR} = 0$	0500	120		μV		
Output noise voltage, rms	f = 10 Hz to 10 kHz	C _{NR} = 1 μF	25°C	30				
	V + 0.40′ L + 40 A	C _L = 0	0500		290			
	V_{O} to 0.1%, $I_{O} = \pm 10$ mA	C _L = 100 pF	25°C	275				
Output voltage current step response		C _L = 0	0500		400		μs	
	V_{O} to 0.01%, $I_{O} = \pm 10 \text{ mA}$	C _L = 100 pF	25°C		390			
Cton recononce	$V_I = 0 \text{ to } 12 \text{ V}, V_O \text{ to } 0.1\%$	C _I = 100 pF	0500		12			
Step response	V _I = 0 to 12 V, V _O to 0.01%	CL = 100 pF	25°C	120			μs	



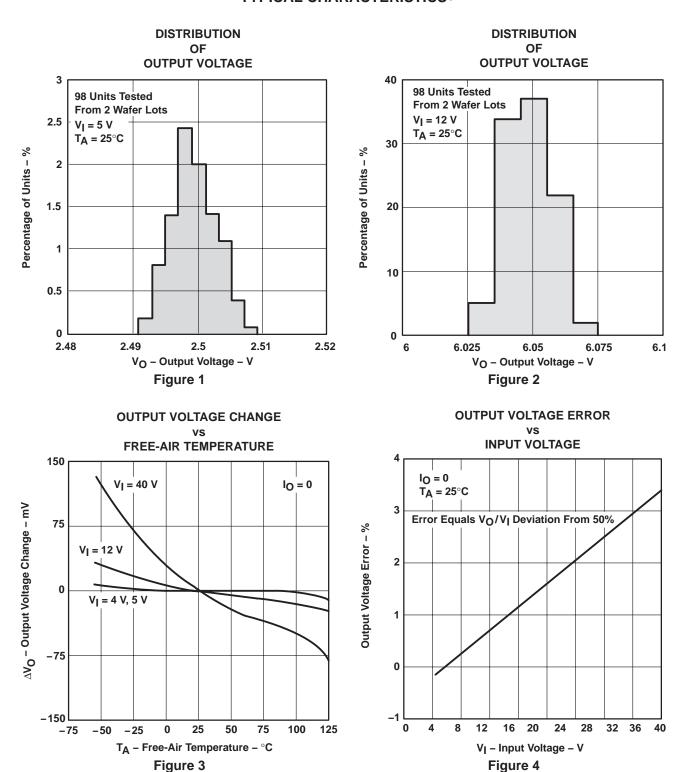
[†] Full range is –40°C to 125°C. ‡ The listed values are not production tested.

TYPICAL CHARACTERISTICS

Table Of Graphs

		FIGURE
Output voltage	Distribution	1, 2
Output voltage change	vs Free-air temperature	3
Output voltage error	vs Input voltage	4
Invest his a summer	vs Input voltage	5
Input bias current	Distribution vs Free-air temperature vs Input voltage vs Input voltage vs Free-air temperature vs Output current vs Frequency vs Input voltage vs Free-air temperature vs Frequency vs Free-air temperature vs Frequency vs Frequency	6
Output voltage regulation	vs Output current	7
Output impedance	vs Frequency	8
Object size it autout summer.	vs Input voltage	9, 10
Short-circuit output current	vs Free-air temperature vs Input voltage vs Input voltage vs Free-air temperature vs Output current vs Frequency vs Input voltage vs Free-air temperature vs Frequency vs Frequency vs Frequency vs Frequency vs Time vs Time	11, 12
Ripple rejection	vs Frequency	13
Spectral noise voltage density	vs Frequency	14
Output voltage response to output current step	vs Time	15
Output voltage power-up response	vs Time	16
Output current	vs Load capacitance	17

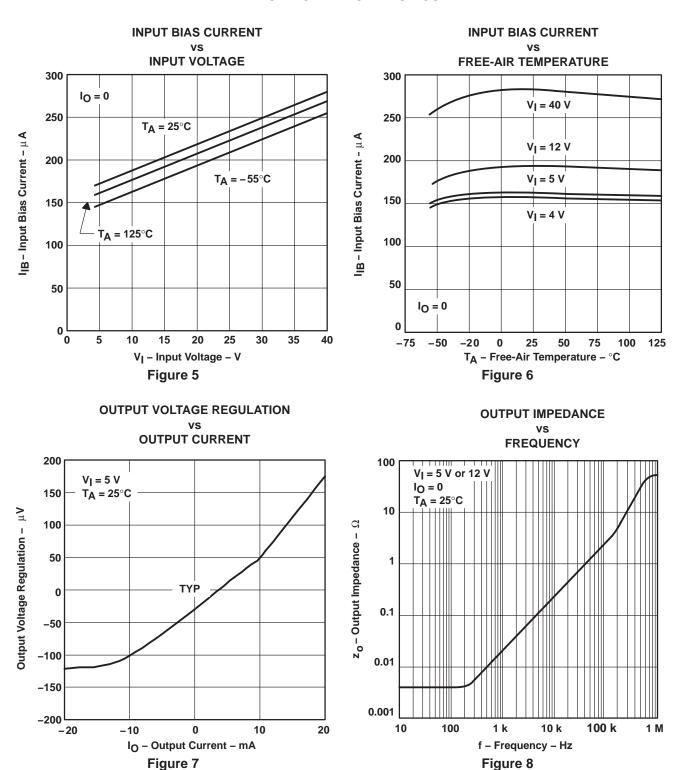
TYPICAL CHARACTERISTICS[†]



[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



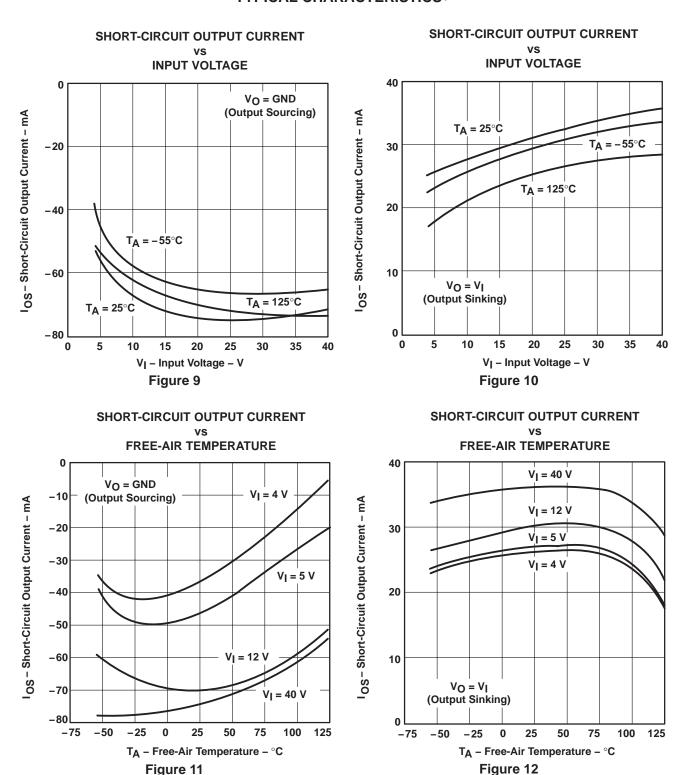
TYPICAL CHARACTERISTICS[†]



[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS[†]



[†] Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS

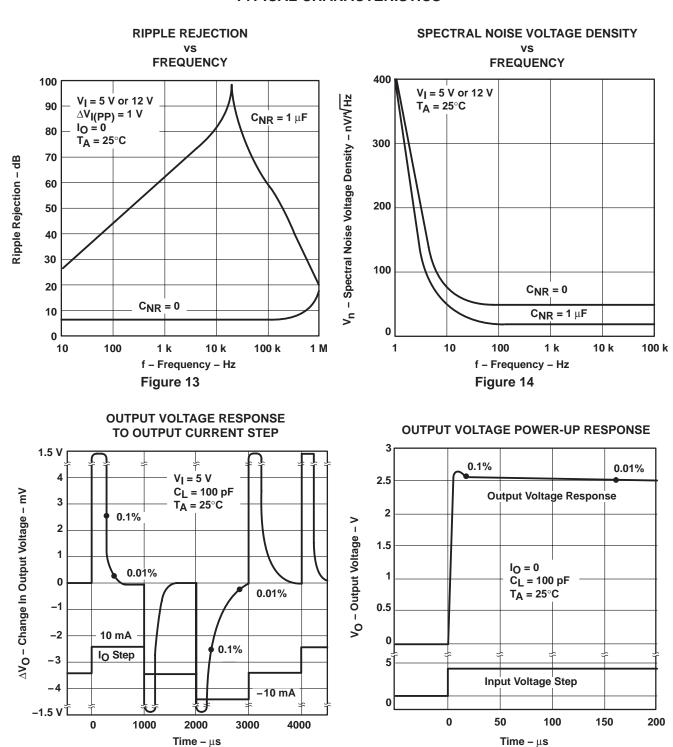


Figure 15

Figure 16

TYPICAL CHARACTERISTICS

STABILITY RANGE OUTPUT CURRENT VS

LOAD CAPACITANCE

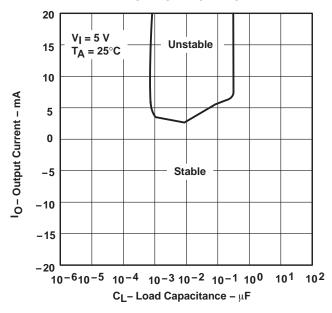


Figure 17



MACROMODEL INFORMATION

TLE2426 OPERATIONAL AMPLIFIER "MACROMODEL" SUBCIRCUIT

```
CREATED USING PARTS RELEASE 4.03 ON 08/21/90 AT 13:51
                 SUPPLY VOLTAGE: 5 V
   REV (N/A)
   CONNECTIONS:
                    FILTER
                        INPUT
                           COMMON
                               OUTPUT
.SUBCKT TLE2426
                               5
   C1
          11 12 21.66E-12
   C2
              7 30.00E-12
   C3
          87
              0 10.64E-9
   CPSR
          85 86 15.9E-9
   DCM+
          81 82 DX
   DCM-
          83
             81 DX
   DC
           5
             53 DX
   DE
          54
              5 DX
   DLP
             91 DX
          90
   DLN
          92
             90
                DX
   DP
           4
              3 DX
   ECMR
          84
             99 (2,99) 1
                           (3,0) (4,0) 0 .5 .5
(3,4) -16.22E-6 3.24E-6
   EGND
          99
              0 POLY(2)
          85
   EPSR
              0
                POLY(1)
   ENSE
              2 POLY(1)
                           (88,0) 120E-61
   FΒ
           7
             99 POLY(6)
                           VB VC VE VLPVLNVPSR 0 74.8E6 - 10E6 10E6 10E6 - 10E6 74E6
   GA
           6
              0
                11 12 320.4E-6
              6 10 99 1.013E-9
   GCM
           0
                 (85,86)
   GPSR
          85 86
                           100E-6
   GRC1
           4
             11
                 (4,11) 3.204E-4
                 (4,12) 3.204E-4
   GRC2
           4 12
   GRE1
          13 10 (13,10)
                         1.038E-3
   GRE2
          14 10 (14,10)
                           1.038E-3
              0 VLIM 1K
   HT.TM
          90
   HCMR
          80
             1 POLY(2)
                           VCM+
                                  VCM-
                                         0 1E2
                                                   1E2
   IRP
           3
              4 146E-6
   IEE
           3 10 DC 24.05E-6
   IIO
           2
             0.2E - 9
              0 1E-21
   T 1
          88
   Q1
          11
             89 13 QX
          12 80 14 QX
   02
   R2
           6
              9 100.0E3
          84
   RCM
             81 1K
   REE
          10 99
                 8.316E6
   RN1
          87
              0
                 2.55E8
          87
             88 11.67E3
   RN2
   RO1
           8
              5
                63
           7
             99 62
   RO2
   VCM+
          82
             99 1.0
   VCM-
          83
             99
                 -2.3
              0 DC 0
   VB
           9
   VC
           3
             53 DC 1.400
   VE
          54
              4 DC
                    1.400
           7
              8 DC
   VLIM
                    Ω
   VLP
          91
              0 DC 30
           0 92 DC
   VLN
                    30
   VPSR
           0
             86 DC
                    0
   RFB
             2 1K
   RTN1
              1 220K
           3
   RIN2
           1
              4 220K
.MODEL DX D(IS=800.OE-18)
.MODEL QX PNP(IS=800.OE-18BF=480)
```



.ENDS

www.ti.com 11-Nov-2025

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
TLE2426QDRG4Q1	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2426Q1
TLE2426QDRG4Q1.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2426Q1

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TLE2426-Q1:

Catalog: TLE2426

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

www.ti.com 11-Nov-2025

● Enhanced Product : TLE2426-EP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025